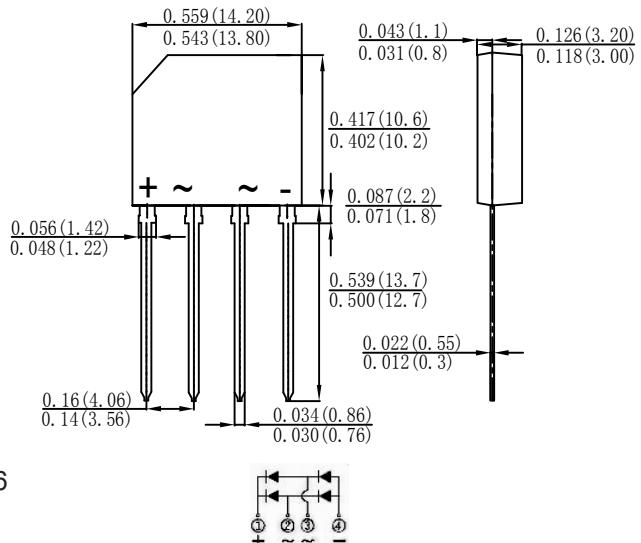




## SINGLE BRIDGE RECTIFIERS

**Features**

- ◆ Glass Passivated Chip Junction
- ◆ Low forward voltage drop
- ◆ High current capability
- ◆ High surge current capability
- ◆ The Plastic material has UL flammability 94V-0

**KBP** 

Dimensions in inches and (millimeters)

**Mechanical Data**

Case : JEDEC KBP Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.050 ounce, 1.52 grams

**Maximum Ratings And Electrical Characteristics**

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	MDD KBP4005	MDD KBP401	MDD KBP402	MDD KBP404	MDD KBP406	MDD KBP408	MDD KBP410	UNITS
Marking Code									
Maximum repetitive peak reverse voltage	V <sub>RPM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum average forward output rectified current at T <sub>c</sub> =100°C (With heatsink) (Without heatsink)	I <sub>(AV)</sub>					4.0			A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>					90			A
Maximum instantaneous forward voltage drop per bridge element at 4.0A	V <sub>F</sub>				1.1				V
Maximum DC reverse current TA=25°C at rated DC blocking voltage TA=125°C	I <sub>R</sub>				10				µA
					1				mA
I <sup>2</sup> t Rating for fusing (3ms≤t≤8.3ms)	I <sup>2</sup> t				35				A <sup>2</sup> S
Typical Junction Capacitance per element (Note 2)	C <sub>j</sub>				50				pF
Typical Thermal Resistance (Note 2)	R <sub>θJA</sub> R <sub>θJC</sub> R <sub>θJL</sub>				55 14 20				°C/W
Operating junction temperature range	T <sub>J</sub>				-55 to +150				°C
Storage temperature range	T <sub>STG</sub>				-55 to +150				°C

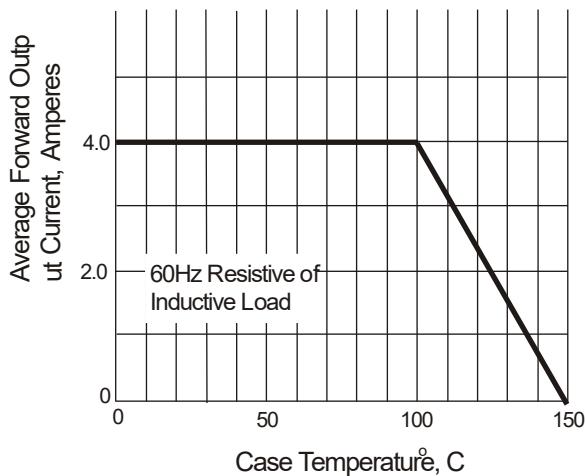
Note:1. Mounted on glass epoxy PC board with 1.3mm<sup>2</sup> solder pad.

2. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.

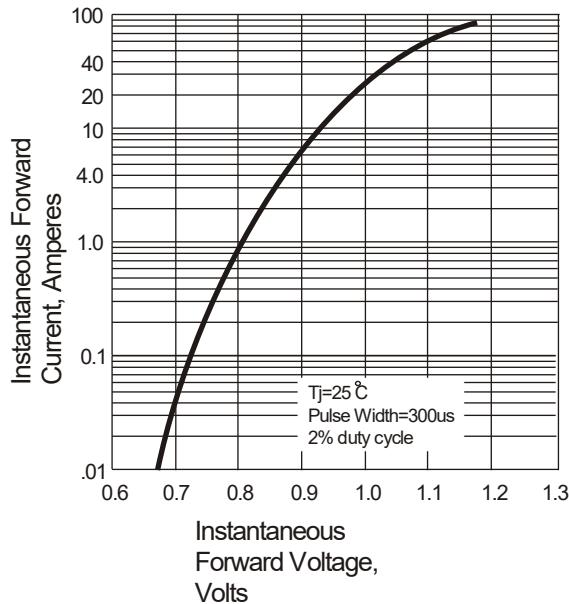


## Ratings And Characteristic Curves

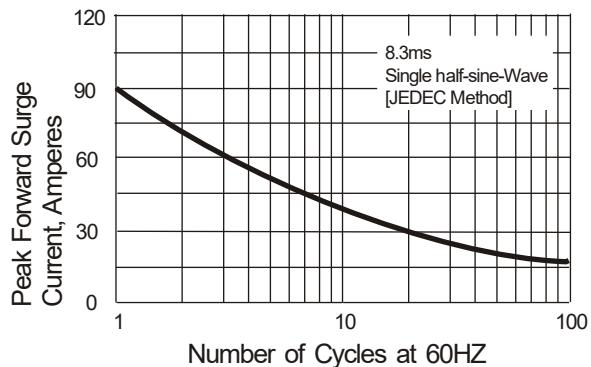
**Fig. 1 Derating Curve for Output Rectified Current**



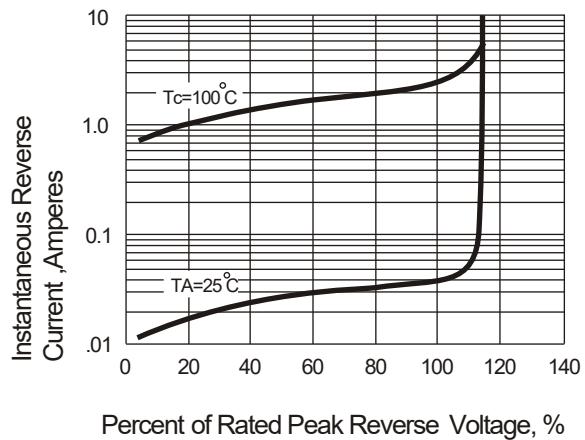
**Fig. 3 Typical Instantaneous Forward Characteristics**



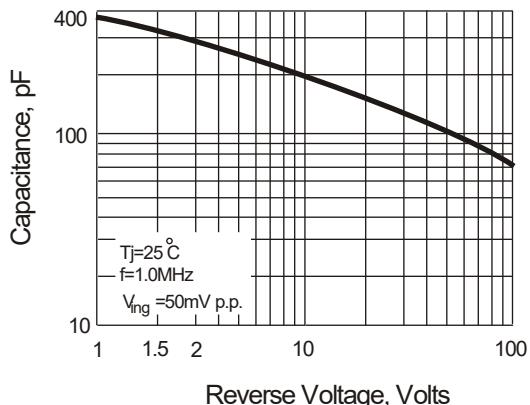
**Fig. 2 Maximum Non-repetitive Peak Forward Surge Current**



**Fig. 4 Typical Reverse Characteristics**



**Fig. 5 Typical Junction Capacitance**



The curve above is for reference only.